L Number	Hits	Search Text	DB	Time stamp
-	0	("heatherwithlong.xa.").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:29
-	4	(heather with long).xa.	USPAT	2004/05/27 13:17
-	361	(camera or ccd) with metal with plate and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 13:27
-	1	09/769455	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 13:42
-	19	metal with plate with open$3 with (ccd or camera) and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 15:22
-	0	bit$2plane with sensor$2bit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 15:22
-	2	pixel$2bit with sensor$2bit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 15:24
-	0	pixel$2bit with bitplane	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 15:24
-	0	pixel$2bit and bitplane	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 15:24
-	1	pixel$2bit and bit$2plane	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 16:11
-	1	09/771580	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 16:12
-	1	09/772662	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/27 16:12
-	47	ccd with adhesive with plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 11:06
-	42	ccd with adhesive with plate and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 13:33
-	602	(circuit or board or print$3) with plate with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 13:34

-	24	(circuit or board or print$3) with metal with plate with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 14:14
-	2	6308892.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/14 14:14
-	1	(masaharu with taku).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:34
-	1	(taku with masaharu).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 13:55
-	6	metal with plate with (open$3 or hole) with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:05
-	16	(tomio with nagai).in. and toshiba.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:13
-	1276	matsumoto.in. and sony.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:13
-	2	jp with "57002573"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:29
-	452	348/335.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:29
-	0	348/335,340,374,375,45,65 and (plate with open$3 with ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:30
-	7	348/335,340,374,375,45,65.ccls. and (plate with open$3 with ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 14:47
-	220	348/374.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 15:26
-	0	("5087964,4630095,4594613").PN.	USPAT	2004/06/16 15:27
-	0	5087964,4630095.pn.	USPAT	2004/06/16 15:28
-	0	5087964.pn. and 4630095.pn.	USPAT	2004/06/16 15:28
-	1	5087964.pn.	USPAT	2004/06/16 15:28
-	1	("5087964").PN.	USPAT	2004/06/16 15:30
-	0	("5087964,4630095,4594613,5596229").PN.	USPAT	2004/06/16 15:31
-	0	5087964,4630095,4594613,5596229.pn.	USPAT	2004/06/16 15:31
-	0	(5087964,4630095,4594613,5596229).pn.	USPAT	2004/06/16 15:31

-	11	(("5087964") or ("4630095") or ("4594613") or ("5596229") or ("5072283") or ("5550398") or ("5150180") or ("4803557") or ("4990719") or ("5563067") or ("5731834")).PN.	USPAT	2004/06/16 17:21
-	0	JP-10186188-A.DID. and (adhesive or glue or paste)	USPAT	2004/06/16 17:22
-	4	((("5087964") or ("4630095") or ("4594613") or ("5596229") or ("5072283") or ("5550398") or ("5150180") or ("4803557") or ("4990719") or ("5563067") or ("5731834")).PN.) and (adhesive or glue or paste)	USPAT	2004/06/16 17:22
-	214	257/$.ccls. and (hous$3 with (pixel or (imag$3 with sens$3)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 10:55
-	114	257/$.ccls. and (hous$3 with (pixel or (imag$3 with sens$3))) and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 12:17
-	8	("4803557" | "5221964" | "5483284" | "5596229" | "5781807" | "5861654" | "5946404" | "6351288").PN.	USPAT	2004/06/18 11:28
-	534	348/373,374.ccls. and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 12:37
-	1	(metal with jig) and 348/373,374.ccls. and @ad<=20001028	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 12:46
-	22235	(pcb or (circuit with board)) with open$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 12:47
-	2179	(pcb or (circuit with board)) near2 open$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 12:47
-	4	((pcb or (circuit with board)) near2 open$3) with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 12:48
-	154	257/711.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 10:58
-	3	257/711.ccls. and ((mount$3 with plate) with adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:47
-	24	adhesive with (image with sensor) with open$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:50
-	51	plate with open$3 with adhesive and ((image adj sensor) or ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 15:52

-	24	plate with open$3 with adhesive and ((image adj sensor) or ccd) and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 16:34
-	1	IIJIMA.IN. and mizoguchi.in. and olympus.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 16:35
-	918	257/686.ccls. and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 16:36
-	1245	257/678.ccls. and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 16:36
-	29	257/678.ccls. and @ad<=20001231 and (adhesive with open$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 11:34
-	10	257/688,699.ccls. and (adhesive with open$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 17:15
-	29	257/678.ccls. and @ad<=20001231 and (adhesive with open$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 11:49
-	0	wo with 00/33163	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 11:50
-	0	00/33163	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 11:51
-	1	WO-200033163-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:33
-	1	2000-423044.NRAN.	DERWENT	2004/06/23 11:53
-	1768	adhesive with inner with circumferen$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:33
-	2	adhesive with inner with circumferen$4 with ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:37
-	4	adhesive with inner with circumferen$4 same ccd	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:50
-	1	09/771580	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:55

-	2	348/45,65.ccls. and adhesive with open$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 13:55
-	454	348/45,65.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:02
-	24	348/45,65.ccls. and adhesive and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:13
-	1	09/827942	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:48
-	0	ep0773673a1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:49
-	875	257/433.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:50
-	0	ep with 0773673a1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:51
-	0	ep with "0773673"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:51
-	3	"0773673"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:52
-	2	ep with "773673"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:57
-	2	6122009.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 14:57
-	1222	250/239.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:09
-	142	250/239.ccls. and adhesive and @ad<=20001231	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:10
-	128	250/239.ccls. and adhesive and @ad<=20000128	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:33

-	306729	(CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:33
-	226266	(metal) near2 (shield$3 or plate$1 or hold$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:34
-	5402058	open$3 or aperture or hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:34
-	3077841	corner or edge or lip or projection	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:35
-	3504849	adhesive or glue or resin or epoxy or polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:35
-	1611	((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) and ((metal) near2 (shield$3 or plate$1 or hold$3)) and (open$3 or aperture or hole) and (corner or edge or lip or projection) and (adhesive or glue or resin or epoxy or polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:41
-	30086	((metal) near2 (shield$3 or plate$1 or hold$3)) with (open$3 or aperture or hole)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:37
-	5802	(((metal) near2 (shield$3 or plate$1 or hold$3)) with (open$3 or aperture or hole)) same (corner or edge or lip or projection)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:38
-	38	((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) and (adhesive or glue or resin or epoxy or polymer) and ((((metal) near2 (shield$3 or plate$1 or hold$3)) with (open$3 or aperture or hole)) same (corner or edge or lip or projection))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:41
-	102	((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) same ((metal) near2 (shield$3 or plate$1 or hold$3)) same (adhesive or glue or resin or epoxy or polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:56
-	5	((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) same ((metal) near2 (shield$3 or plate$1 or hold$3)) same (open$3 or aperture or hole) same (corner or edge or lip or projection) same (adhesive or glue or resin or epoxy or polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:44
-	2993188	pack$7 or hous$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:57

-	8	((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) with (mount$3) with (pack$7 or hous$3) with ((metal) near2 (shield$3 or plate$1 or hold$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:00
-	10408	((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) with (pack$7 or hous$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:00
-	18	(((CCD or (charge adj1 coupled) or imager or (imag$3 adj1 (sens$3 or pick$1up or device or array or apparatus)))) with (pack$7 or hous$3)) same ((metal) near2 (shield$3 or plate$1 or hold$3)) same (mount$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:02
-	17	ccd with opening with adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 09:08
-	2	5952714.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 09:10
-	2	"6693674"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:33
-	1	09/769455	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:51
-	390	(ultraviolet with cur$3 with adhesive) and visco$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:52
-	250	(ultraviolet with cur$3 with adhesive) and visco$3 and @ad<=20000101	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:53